

SPECIFICATION FOR APPROVAL

CUSTOMER : _____

PRODUCT TYPE : SMD TCXO 2.5 * 2.0

NOMINAL FREQ. : 26 MHz

TXC P/N : 7L26002009

REVISION : A1

CUSTOMER P/N : _____

PM / SALES : _____

DATE : _____

CUSTOMER SIGNATURE & DATE

: _____

- (1) TXC requires one copy returned with signature and title of authorized individual that signifies acceptance of the attached specifications.
- (2) Orders received and accepted by TXC after return of signed copy of specification will be produced per these specifications.
- (3) Any changes to these specifications must be agreed upon by both parties and new revision of the Product Specification Sheet will be issued.
- (4) Any issuance of purchase order prior to consigning back the Approval page of "Specification Sheets" from customers will be regarded as the agreement on the contents of these specifications.

Attachment: Product Specification Sheet

1
2
3
4
5

RoHS Compliant

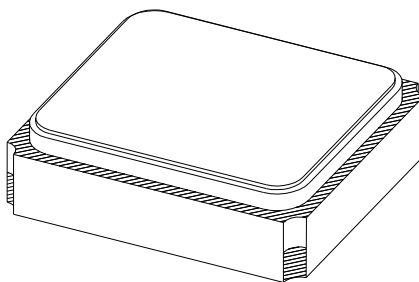
PRODUCT SPECIFICATION SHEET

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PE/RD	QA	MFG
<i>Kenneth</i> 4/6 '11	<i>Chester</i> 4/7 '11	<i>Wang</i> 2011.11.7

NOTE:

- (1) Lead Free Products are " Directive 2002/95/EC of The European Parliament of 27 January 2003 on the restriction of the use of certain hazardous substances (RoHS) in electrical and electronic equipment" Compliant (Attachment: SGS Test Report).
- (2) Revision "Sx" is for engineering samples only. PE/RD's approval required.
- (3) Revision "Ax" is production ready. PE, QA and MFG's approval required.

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ELECTRICAL SPECIFICATIONS

Item	Parameters		Condition	Electrical Specifications				Note
				MIN	TYP	MAX	UNITS	
1	Nominal Frequency			26.000000			MHz	
2	Operating Temperature Range			-40		+85	°C	
3	Supply Voltage			1.70	1.80	1.90	V	
4	Current Drain					1.5	mA	
5	Output Level			0.8			V	1
6	Output Type			Clipped Sinewave				
7	Output Load	Resistance		9	10	11	kΩ	
8		Capacitance		9	10	11	pF	
9	Frequency Tolerance		After 2 times reflow			±2.0	ppm	2
10	Frequency Stability	vs. Temperature	Temp: -30 ~ +85 °C			±0.5	ppm	3,4
11			Temp: -40 ~ -30 °C			±3	ppm	3,4
12		vs. Load	Load: 10 kΩ // 10 pF ±10%			±0.1	ppm	
13		vs. Supply Voltage	Vcc: 1.8V ±5%			±0.1	ppm	
14	Slope of Frequency Drift over Temperature		Temp: -20 ~ +65°C			±0.05	ppm/°C	4
15			Temp: -30 ~ +85°C			±0.1	ppm/°C	
16			Temp: -40 ~ -30°C			±0.35	ppm/°C	
17	Static Temperature Hysteresis					±0.6	ppm	5
18	Storage Temperature			-40		+85	°C	
19	Start-up Time	vs. Frequency	Within ± 0.5 ppm			2.0	ms	
20		vs. Output Level	To 90% of Vp-p			2.0	ms	
21	Duty Cycle			40	50	60	%	
22	Aging		1 st year			±1.0	ppm/year	
23			2 nd year			±1.5	ppm/year	
24			5 th year			±2.5	ppm/year	
25			10 th year			±5	ppm/year	
26	Harmonics					-8	dBc	
27	Phase Noise	@ 1 Hz offset			-50		dBc/Hz	
28		@ 10 Hz offset			-80		dBc/Hz	
29		@ 100 Hz offset			-105		dBc/Hz	
30		@ 1 kHz offset			-130		dBc/Hz	
31		@ 10 kHz offset			-148		dBc/Hz	
32		@ 1 MHz offset			-150		dBc/Hz	

Note 1 Decoupling capacitor is required in external circuit.

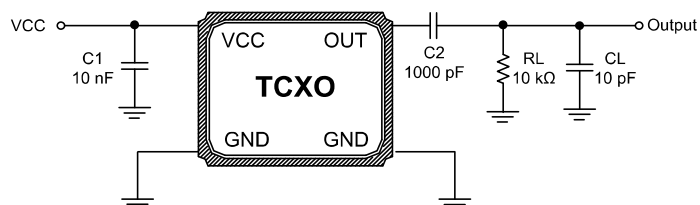
Note 2 Refer to nominal frequency

Note 3 Refer to frequency before reflow

Note 4 Minimum of 1 frequency reading every 2°C over temperature, based on temperature varied at maximum of 2°C per minute.

Note 5 Frequency deviation at 25°C after reciprocal temperature cycle over the operating temperature range

■ TESTING CIRCUIT

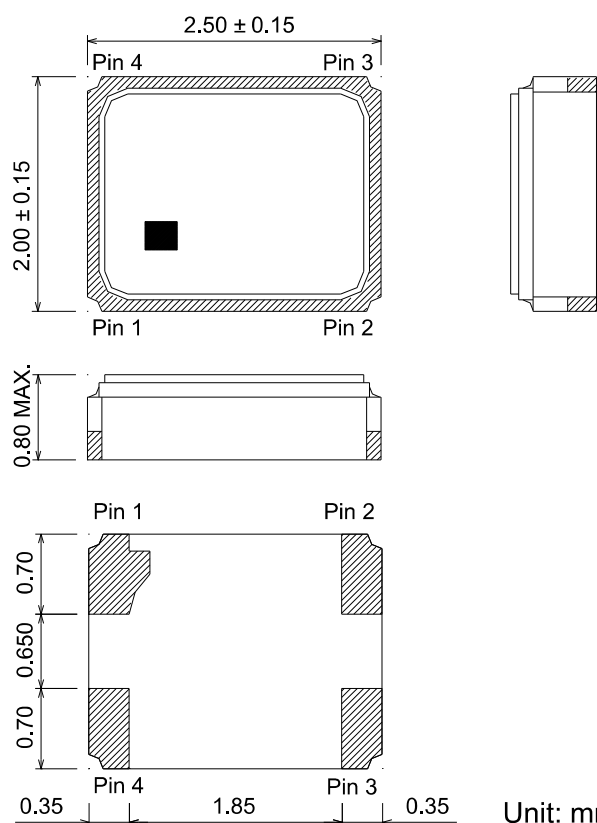


External Components

Name	Function
C1	AC Noise Bypass for VCC
C2	DC Block for Output
RL	Load Resistance
CL	Load Capacitance

Note: Bypass capacitor (C1) and DC blocking capacitor (C2) should be placed.

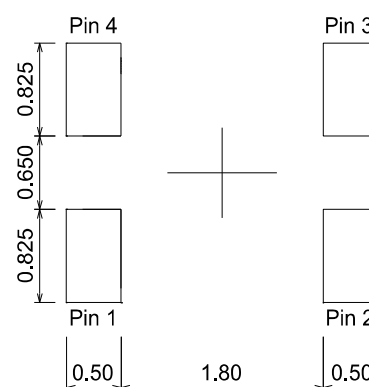
■ DIMENSIONS



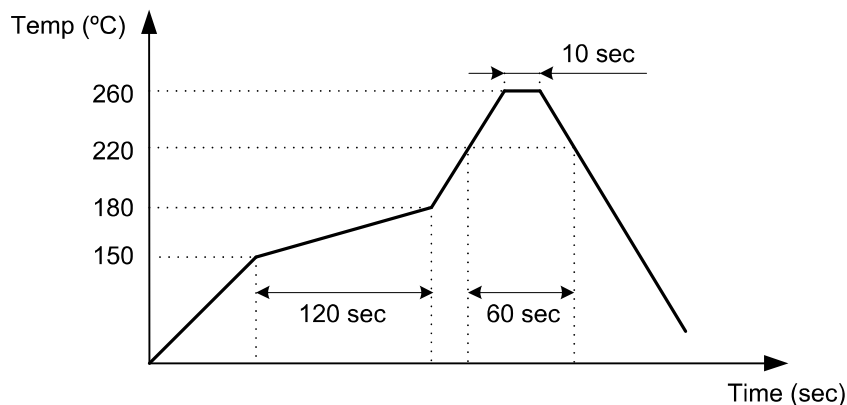
Pin Connection

Name	Function
Pin 1	GND
Pin 2	GND
Pin 3	OUTPUT
Pin 4	VCC

Recommended Land Pattern

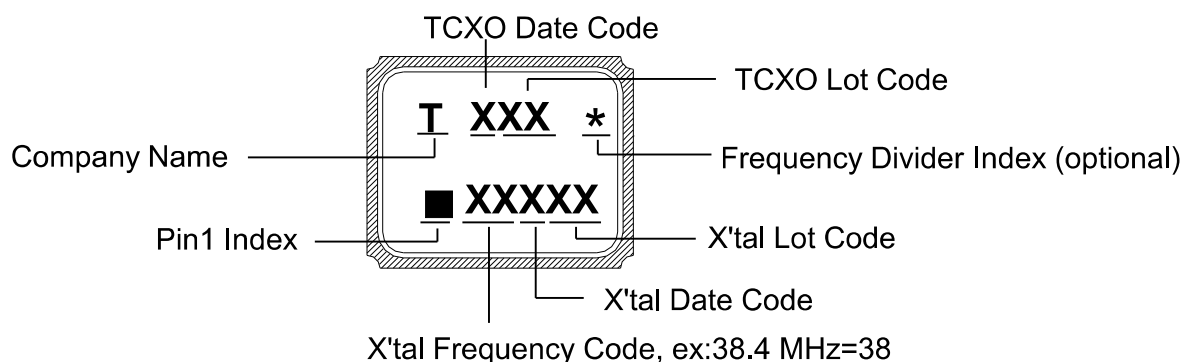


■ SUGGESTED REFLOW PROFILE



Note : Total Time: 200 sec. Max., Solder Melting Point: 220°C

■ MARKING



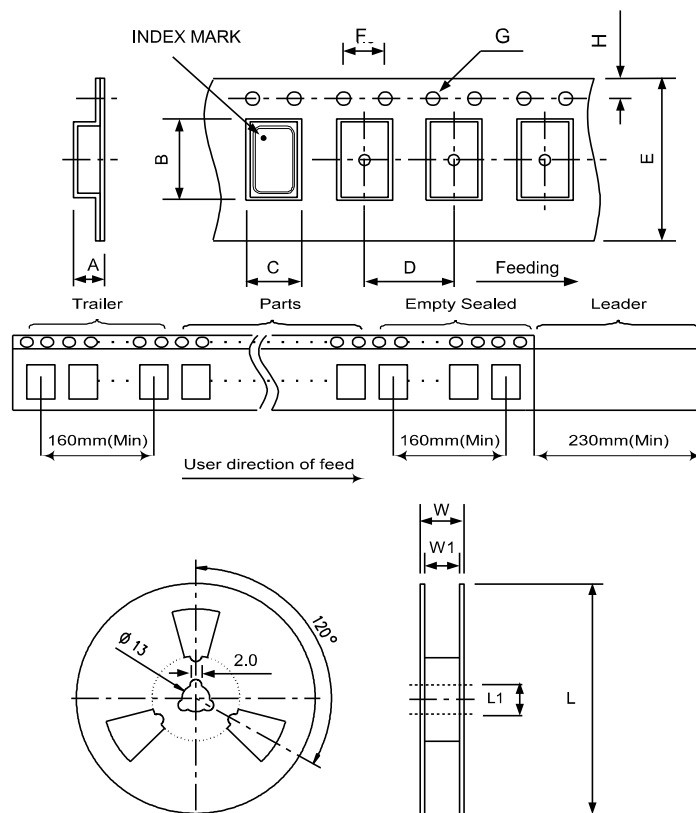
DATE CODE

YEAR				MONTH											
				JAN	FEB	MAR	APR	MAY	JUN	JUL	AUG	SEP	OCT	NOV	DEC
2005	2009	2013	2017	A	B	C	D	E	F	G	H	J	K	L	M
2006	2010	2014	2018	N	P	Q	R	S	T	U	V	W	X	Y	Z
2007	2011	2015	2019	a	b	c	d	e	f	g	h	j	k	l	m
2008	2012	2016	2020	n	p	q	r	s	t	u	v	w	x	y	z

* This date code will be cycled every four years.

Note: If TCXO frequency is X'tal frequency divided by 2, then frequency divider index appears.
If TCXO frequency is the same as X'tal frequency, then no frequency divider index appears.

■ **PACKING : (EIA-481-2)**



Unit: mm

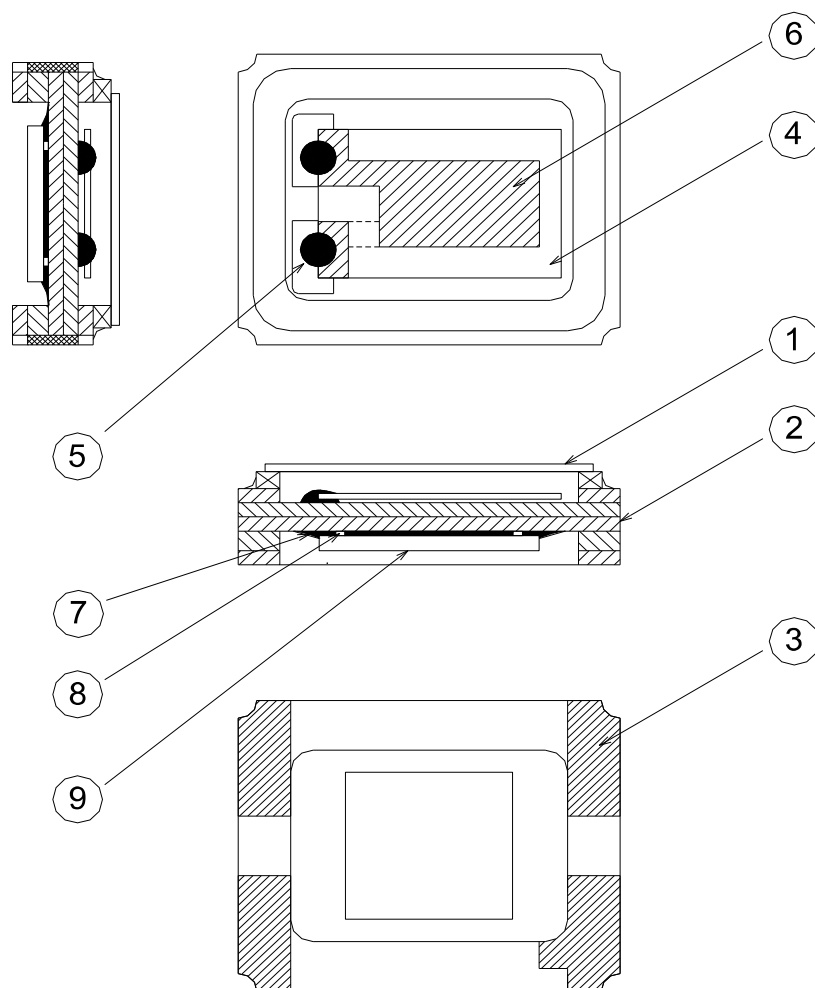
DIMENSIONS (mm)	A	B	C	D	E	F	G	H	L	L1	W	W1	Standard Reel Quantity is 3,000 pcs per reel
	1.15	2.70	2.25	4.00	8.00	4.00	1.55	1.75	178	13.0	11.6	8.4	

WEIGHT

0.0135 g / piece(TYP), 40 ± 2 g /3 kpcs(regardless of tape weight)

■ STRUCTURE ILLUSTRATION

Crystal Enclosure Seal: Seam Welding



No.	COMPONENTS	MATERIALS	FINISH/SPECIFICATIONS
1	Cap	Metal(Fe + Co + Ni)	-
2	Base	Ceramic	Color Black
3	Pad	Au	Tungsten Metalize + Ni Plating + Au Plating
4	Crystal Blank	SiO ₂	-
5	Conductive Adhesive	Ag	Silicone Resin
6	Electrode	Noble Metal	-
7	Underfill	Organic	Color Black
8	Bump	Au	
9	IC	Si	

■ RELIABILITY SPECIFICATIONS**1. Mechanical Endurance**

No.	Test Item	Test Methods	Criteria
1.1	Drop Test	Hegiht : 100 cm height Direction : X,Y,Z 6 directions Test cycles : 3 cycles Fall freely on to concrete floor Mounting on test fixture (total weight=100 g)	+/- 2.0 ppm
1.2	Mechanical Shock	Acceleration : 1000 g Duration : 0.5 ms Test cycles : 3 times for all 3 directions	+/- 2.0 ppm
1.3	Vibration	Frequency range : 10 ~ 2000 Hz Amplitude : 1.52 mm (10 ~ 80 Hz) Acceleration : 20 g (80 ~ 2000 Hz) Sweep speed : 20 minutes/cycle Direction : X,Y,Z 3 directions Duration : 4 hours/each direction	+/- 2.0 ppm
1.4	Gross Leak	Standard sample for automatic gross leak detector. Test Pressure : 2 kg/cm ²	< 1.5 × 10 ⁻⁵ Pa m ³ / sec
1.5	Fine Leak	Helium bomging 4.5 kgf/cm ² for 2 hours	< 1.0 × 10 ⁻⁹ Pa m ³ / sec
1.6	Solderability	Preheate temperature : 125°C ± 5°C Preheate time : 120 sec Solding temperature : 245°C ± 5 °C Duration : 5 ± 1 sec Method : Solder bath method	90% Coated

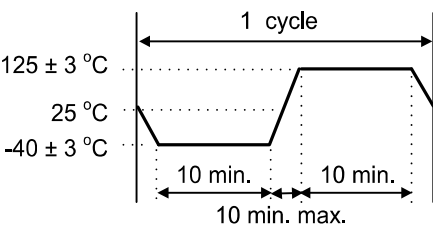
[Note] Criteria mean the maximum frequency change after reliability test, frequency shell be measured at 25°C.

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2. Environmental Endurance

No.	Test Item	Test Methods	Criteria
2.1	High Temp. Storage	Temperature : $+125^{\circ}\text{C} \pm 3^{\circ}\text{C}$ Duration : 168 hours	+/- 2.0 ppm
2.2	Low Temp. Storage	Temperature : $-40^{\circ}\text{C} \pm 3^{\circ}\text{C}$ Duration : 500 hours	+/- 2.0 ppm
2.3	Thermal Shock (Air to Air)	Total 100 cycles of the following temperature cycle : 	+/- 2.0 ppm
2.4	High Temp & Humidity	Temperature : $85^{\circ}\text{C} \pm 3^{\circ}\text{C}$ Humidity: RH 85% Duration : 168 hours	+/- 2.0 ppm
2.5	Aging	Temperature : $85^{\circ}\text{C} \pm 3^{\circ}\text{C}$ Duration : 500 hours Voltage input by specification	+/- 2.0 ppm

[Note] Criteria mean the maximum frequency change after reliability test, frequency shall be measured after 2 hours at 25°C leaving.